

Am29LV256M

**64 Megabit (16 M x 16-Bit/32 M x 8-Bit) MirrorBit™ 3.0 Volt-only
Uniform Sector Flash Memory with VersatileI/O™ Control**

DISTINCTIVE CHARACTERISTICS

ARCHITECTURAL ADVANTAGES

- **Single power supply operation**
 - 2.7–3.6 volt read, erase, and program operations
- **Enhanced VersatileI/O™ control**
 - Device generates data output voltages and tolerates data input voltages as determined by the voltage on the V_{IO} pin; operates from 1.65 to 3.6 V
- **Manufactured on 0.23 µm MirrorBit process technology**
- **SecSi™ (Secured Silicon) Sector region**
 - 128-word/64-byte sector for permanent, secure identification through an 8-word/16-byte random Electronic Serial Number, accessible through a command sequence
 - May be programmed and locked at the factory or by the customer
- **Flexible sector architecture**
 - Five hundred twelve 32 Kword (64 Kbyte) sectors
- **Compatibility with JEDEC standards**
 - Provides pinout and software compatibility for single-power supply flash, and superior inadvertent write protection
- **Minimum 100,000 erase cycle guarantee per sector**
- **20-year data retention at 125°C**

PERFORMANCE CHARACTERISTICS

- **High performance**
 - 90 ns access time
 - 25 ns page read times
 - 1 s typical sector erase time
 - 5.9 µs typical write buffer word programming time: 16-word/32-byte write buffer reduces overall programming time for multiple-word updates
 - 4-word/8-byte page read buffer
 - 16-word/32-byte write buffer

- **Low power consumption (typical values at 3.0 V, 5 MHz)**
 - 30 mA typical active read current
 - 50 mA typical erase/program current
 - 1 µA typical standby mode current
- **Package options**
 - 56-pin TSOP
 - FBGA (Pinout configuration, package dimensions, and ball count to be determined.)

SOFTWARE & HARDWARE FEATURES

- **Software features**
 - Program Suspend & Resume: read other sectors before programming operation is completed
 - Erase Suspend & Resume: read/program other sectors before an erase operation is completed
 - Data# polling & toggle bits provide status
 - Unlock Bypass Program command reduces overall multiple-word or byte programming time
 - CFI (Common Flash Interface) compliant: allows host system to identify and accommodate multiple flash devices
- **Hardware features**
 - Sector Group Protection: hardware-level method of preventing write operations within a sector group
 - Temporary Sector Unprotect: V_{IO}-level method of changing code in locked sectors
 - WP#/ACC input accelerates programming time (when high voltage is applied) for greater throughput during system production. Protects first or last sector regardless of sector protection settings
 - Hardware reset input (RESET#) resets device
 - Ready/Busy# output (RY/BY#) detects program or erase cycle completion

GENERAL DESCRIPTION

The Am29LV256M is a 256 Mbit, 3.0 volt single power supply flash memory devices organized as 16,777,216 words or 33,554,432 bytes. The device have a 16-bit wide data bus that can also function as an 8-bit wide data bus by using the BYTE# input. The device can be programmed either in the host system or in standard EPROM programmers.

An access time of 90 ns is available for applications where $V_{IO} \geq 3.0$ V. An access time of 100 ns is available for applications where $V_{IO} < 3.0$ V. The device is offered in a 56-pin TSOP or an FBGA package (pinout configuration, ball count, and package dimensions to be determined). Each device has separate chip enable (CE#), write enable (WE#) and output enable (OE#) controls.

Each device requires only a **single 3.0 volt power supply** (2.7–3.6 V) for both read and write functions. In addition to a V_{CC} input, a high-voltage **accelerated program (WP#/ACC)** input provides shorter programming times through increased current. This feature is intended to facilitate factory throughput during system production, but may also be used in the field if desired.

The device is entirely command set compatible with the **JEDEC single-power-supply Flash standard**. Commands are written to the device using standard microprocessor write timing. Write cycles also internally latch addresses and data needed for the programming and erase operations.

The **sector erase architecture** allows memory sectors to be erased and reprogrammed without affecting the data contents of other sectors. The device is fully erased when shipped from the factory.

Device programming and erasure are initiated through command sequences. Once a program or erase operation has begun, the host system need only poll the DQ7 (Data# Polling) or DQ6 (toggle) **status bits** or monitor the **Ready/Busy# (RY/BY#)** output to determine whether the operation is complete. To facilitate programming, an **Unlock Bypass** mode reduces command sequence overhead by requiring only two write cycles to program data instead of four.

The **Versatile/O™** (V_{IO}) control allows the host system to set the voltage levels that the device generates

at its data outputs and the voltages tolerated at its data inputs to the same voltage level that is asserted on the V_{IO} pin. This allows the device to operate in a 1.8 V or 3 V system environment as required.

Hardware data protection measures include a low V_{CC} detector that automatically inhibits write operations during power transitions. The hardware sector protection feature disables both program and erase operations in any combination of sectors of memory. This can be achieved in-system or via programming equipment.

The **Erase Suspend/Erase Resume** feature allows the host system to pause an erase operation in a given sector to read or program any other sector and then complete the erase operation. The **Program Suspend/Program Resume** feature enables the host system to pause a program operation in a given sector to read any other sector and then complete the program operation.

The **hardware RESET# pin** terminates any operation in progress and resets the device, after which it is then ready for a new operation. The RESET# pin may be tied to the system reset circuitry. A system reset would thus also reset the device, enabling the host system to read boot-up firmware from the Flash memory device.

The device reduces power consumption in the **standby mode** when it detects specific voltage levels on CE# and RESET#, or when addresses have been stable for a specified period of time.

The **SecSi™ (Secured Silicon) Sector** provides a 128-word/256-byte area for code or data that can be permanently protected. Once this sector is protected, no further changes within the sector can occur.

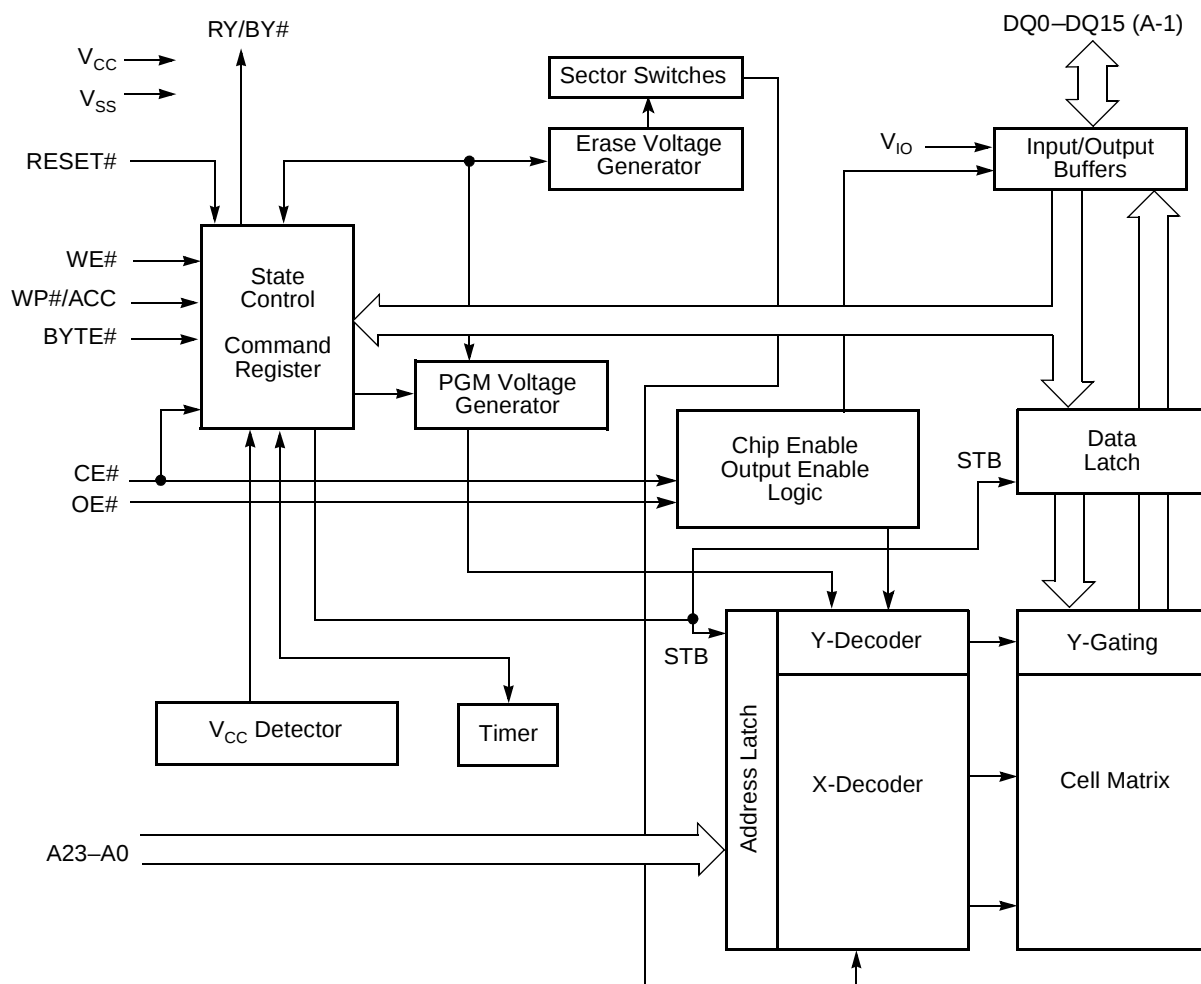
The **Write Protect (WP#/ACC)** feature protects the first or last sector by asserting a logic low on the WP# pin.

AMD MirrorBit flash technology combines years of Flash memory manufacturing experience to produce the highest levels of quality, reliability and cost effectiveness. The device electrically erases all bits within a sector simultaneously via hot-hole assisted erase. The data is programmed using hot electron injection.

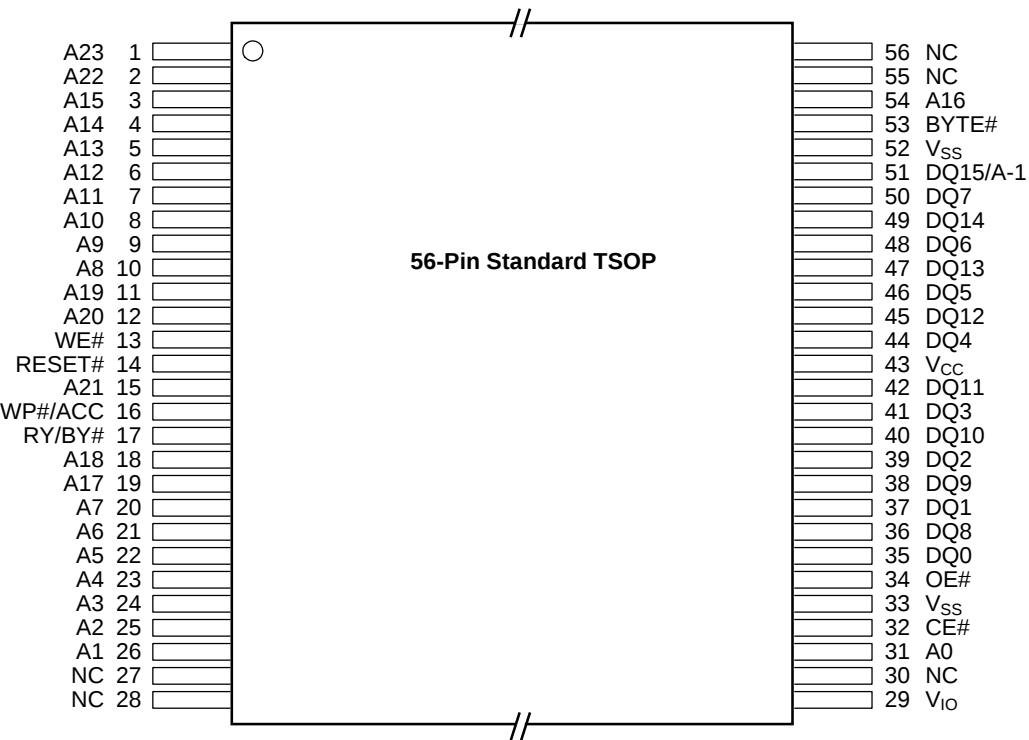
PRODUCT SELECTOR GUIDE

Part Number		Am29LV256M		
Speed Option	$V_{CC} = 2.7\text{--}3.6\text{ V}$ all devices	90 ($V_{IO} = 3.0\text{--}3.6\text{ V}$)	101 ($V_{IO} = 2.7\text{--}3.0\text{ V}$)	102 ($V_{IO} = 1.65\text{--}2.7\text{ V}$)
Max. Access Time (ns)		90	100	100
Max. CE# Access Time (ns)		90	100	100
Max. Page access time (t_{PACC})		25	30	40
Max. OE# Access Time (ns)		25	30	40

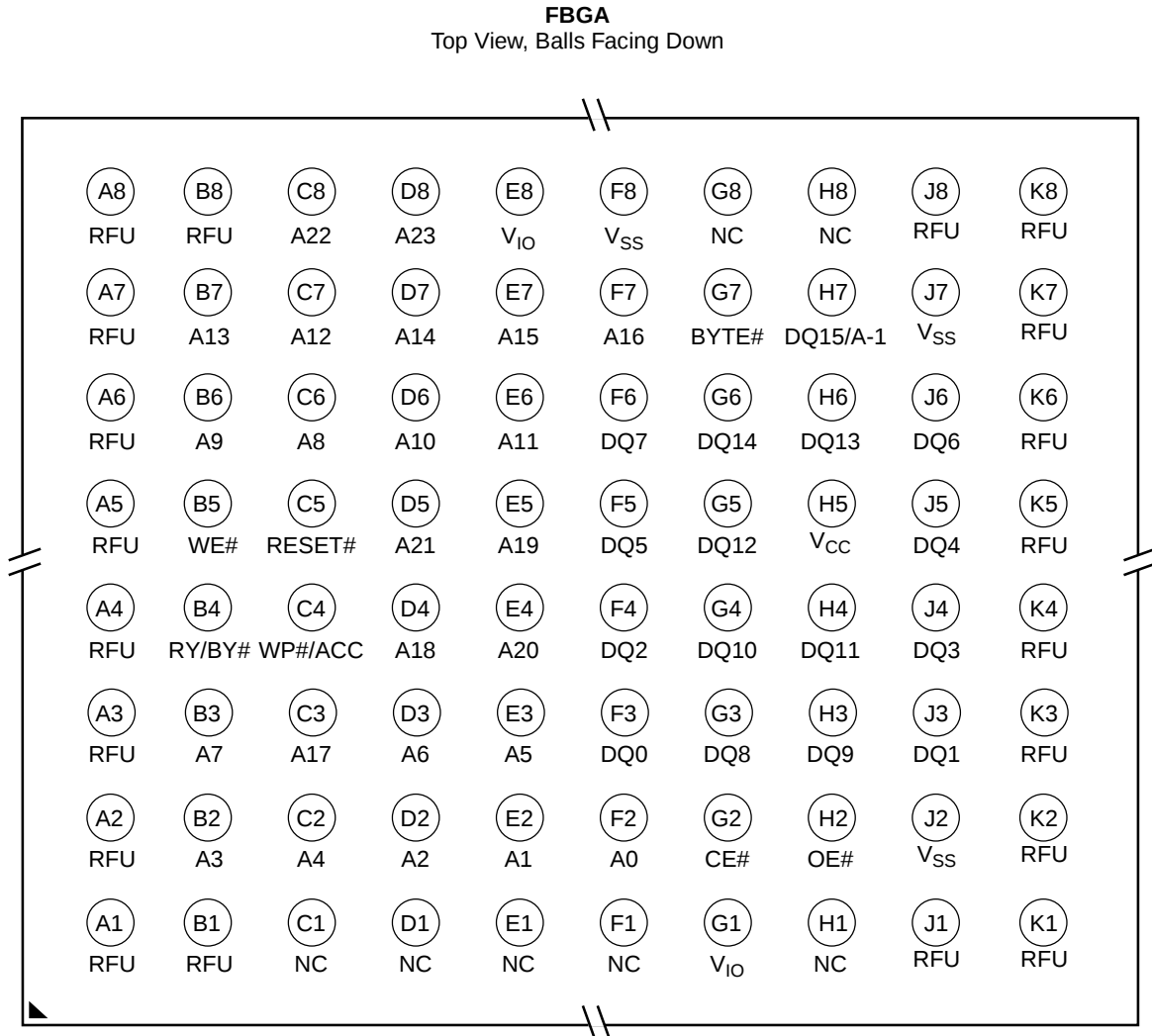
BLOCK DIAGRAM



CONNECTION DIAGRAMS



CONNECTION DIAGRAMS



Note: The FBGA package pinout configuration shown is preliminary. The ball count and package physical dimensions have not yet been determined. Contact AMD for further information. RFU = Reserved for Future Use.

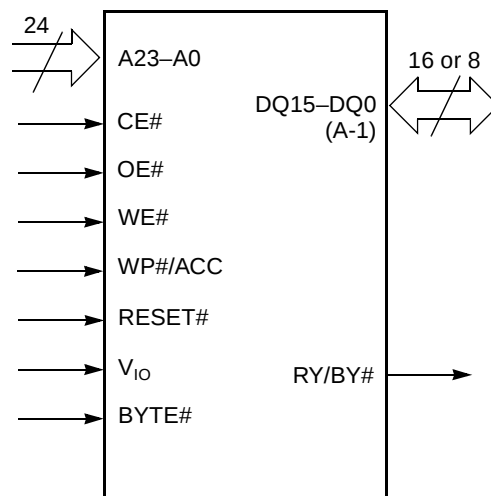
Special Handling Instructions for FBGA Package

Special handling is required for Flash Memory products in FBGA packages.

Flash memory devices in FBGA packages may be damaged if exposed to ultrasonic cleaning methods. The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

PIN DESCRIPTION

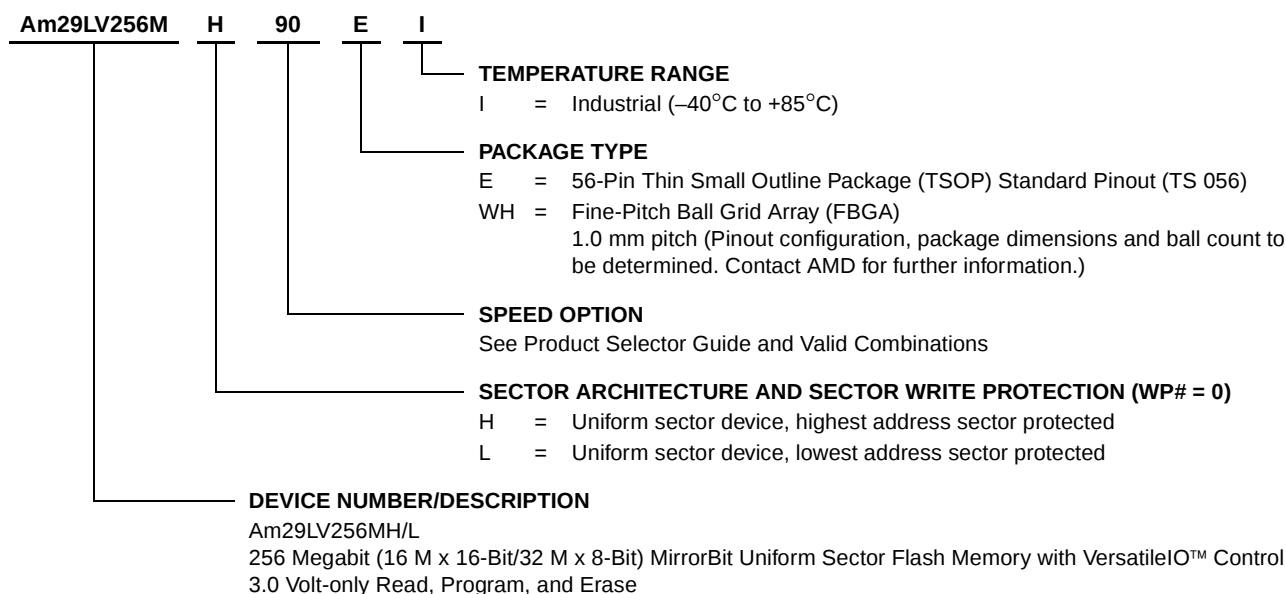
A23–A0	= 24 Addresses inputs
DQ15–DQ0	= 16 Data inputs/outputs
CE#	= Chip Enable input
OE#	= Output Enable input
WE#	= Write Enable input
WP#/ACC	= Hardware Write Protect input; Acceleration Input
RESET#	= Hardware Reset Pin input
BYTE#	= Selects 8-bit or 16-bit mode
RY/BY#	= Ready/Busy output
V _{CC}	= 3.0 volt-only single power supply (see Product Selector Guide for speed options and voltage supply tolerances)
V _{IO}	= Output Buffer power
V _{SS}	= Device Ground
NC	= Pin Not Connected Internally

LOGIC SYMBOL


ORDERING INFORMATION

Standard Products

AMD standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:



Valid Combinations for TSOP Package		Speed/V _{IO} Range
Am29LV256MH90, Am29LV256ML90	EI	90 ns V _{IO} = 2.7–3.6 V
Am29LV256MH101, Am29LV256ML101		100 ns V _{IO} = 2.7–3.0 V
Am29LV256MH102, Am29LV256ML102		100 ns V _{IO} = 1.65–2.7 V

Valid Combinations for FBGA Package		Speed/V _{IO} Range
Order Number	Package Marking	
Am29LV256MH90, Am29LV256ML90	WHI	L256MH90V, L256ML90V
Am29LV256MH101, Am29LV256ML101		L256MH01V, L256ML01V
Am29LV256MH102, Am29LV256ML102		L256MH02V, L256ML02V

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult the local AMD sales office to confirm availability of specific valid combinations and to check on newly released combinations.

REVISION SUMMARY

Revision A (August 3, 2001)

Initial release as abbreviated Advance Information data sheet.

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